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Altera recommends that you create a Quartus[®] II design, enter your device I/O assignments, and compile the design. The Quartus II software will check your pin connections according to I/O assignment and placement rules. The rules differ from one device to another based on device density, package, I/O assignments, voltage assignments, and other factors that are not fully described in this document or the device handbook.

Pin Connection Guidelines

| MAX 10 Pin Name | Pin Type (1st and 2nd Function) | Pin Description | Connection Guidelines |
|--------------------|---------------------------------|--|--|
| Clock and PLL Pins | | | |
| CLK [07]p | Clock, I/O | Dedicated global clock input pins that can also be used for the positive terminal inputs for differential global clock input or user input pins. When these clock input pins are used as single-ended pins, you can disregard the p notation. CLK[07]p pins can function as regular I/O pins. | Connect unused pins to the VCCIO of the bank in which the pins reside or GND. See Notes 2 and 3. |
| CLK[07]n | Clock, I/O | Dedicated global clock input pins that can also be used for the negative terminal inputs for differential global clock input or user input pins. When these clock input pins are used as single-ended pins, you can disregard the n notation. CLK[07]n pins can function as regular I/O pins. | Connect unused pins to the VCCIO of the bank in which the pins reside or GND. See Notes 2 and 3. |
| DPCLK[03] | I/O, Input | DPCLK pins can connect to the global clock network for high fan-out control signals such as clocks, asynchronous clears, presets, and clock enables. | Connect unused pins to the VCCIO of the bank they reside in or GND. These pins can function as regular I/O pins. See Note 3. |

| MAX 10 Pin Name | Pin Type (1st and 2nd Function) | Pin Description | Connection Guidelines |
|----------------------------------|---------------------------------|--|--|
| PLL_[L,R,B,T]_CLKOUTp I/ | 'O, Output | Optional positive terminal for external clock outputs from PLL [14]. These pins can be assigned to single-ended or differential I/O standards if it is being fed by a PLL output. The availability for PLL_[L,R,B,T]_CLKOUTp pins varies for each device density and package combination. For details, refer to the specific device pinout file. | Connect unused pins to GND. These pins can function as regular I/O pins. See Note 3. |
| PLL_[L,R,B,T]_CLKOUTn I/ | 'O, Output | Optional negative terminal for external clock outputs from PLL [14]. These pins can be assigned to single-ended or differential I/O standards if it is being fed by a PLL output. The availability for PLL_[L,R,B,T]_CLKOUTn pins varies for each device density and package combination. For details, refer to the specific device pinout file. | Connect unused pins to GND. These pins can function as regular I/O pins. See Note 3. |
| Configuration/JTAG Pins (Note 8) | | | |
| | nput, I/O | This is a dual-purpose pin. Use this pin to choose the configuration image in the dual-configuration images mode. If the CONFIG_SEL pin is set to low, the first configuration image is configuration image 0. If the CONFIG_SEL pin is set to high, the first configuration image is configuration image 1. This pin is read before user mode and before the nSTATUS pin is asserted. | Connect a weak 10-KΩ pull-up or weak 10-KΩ pull-down to this pin externally during the power-up phase. By default this pin is tri-stated. See Note 10. |

| MAX 10 Pin Name | Pin Type (1st and 2nd Function) | Pin Description | Connection Guidelines |
|-----------------|------------------------------------|--|--|
| CONF_DONE | Bidirectional (open-drain), I/O | This is a dual-purpose pin. The CONF_DONE pin drives low before and during configuration. After all configuration data is received without error and the initialization cycle starts, the CONF_DONE pin is released. | The CONF_DONE pin should be pulled high by an external 10-KΩ pull-up resistor. The MAX 10 device will not enter the initialization and user mode if the CONF_DONE pin is pulled low. Hot socketing is disabled for the CONF_DONE pin. Due to this, a glitch maybe observed at the CONF_DONE pin. To monitor the status of the pin, Altera recommends to implement input buffer with hysteresis and digital filtering with the sampling duration larger than 5.5 ms in the external device to avoid false trip. |
| CRC_ERROR | Output (open-drain), I/O | This is a dual-purpose pin. Active high signal indicates that the error detection circuitry has detected errors in the configuration SRAM bits. The CRC_ERROR pin is an optional pin and is used when the cyclic redundancy check (CRC) error detection circuitry is enabled. | Altera recommends you to tie the CRC_ERROR pin to VCCIO, GND, or leave the pin unconnected when the CRC error detection circuitry is disabled or when you are not using the CRC_ERROR pin. |

| MAX 10 Pin Name | Pin Type (1st and 2nd Function) | Pin Description | Connection Guidelines |
|-----------------|---------------------------------|--|--|
| DEV_CLRn | Input, I/O | This is a dual-purpose pin. Optional chip-wide reset pin that allows you to override all clears on all device registers. When this pin is driven low, all registers are cleared. When this pin is driven high, all registers behave as programmed. The DEV_CLRn pin does not affect JTAG boundary-scan or programming operations. You can enable this pin by turning on the Enable device-wide reset (DEV_CLRn) option in the Quartus II software. | Altera recommends you to tie the DEV_CLRn pin to VCCIO, GND, or leave the DEV_CLRn pin unconnected when you are not using this pin and when the pin is not used as an I/O pin. By default the DEV_CLRn pin is tri-stated. |
| DEV_OE | Input, I/O | This is a dual-purpose pin. Optional pin that allows you to override all tri-states on the device. When this pin is driven low, all I/O pins are tri-stated. When this pin is driven high, all I/O pins behave as programmed. You can enable this pin by turning on the Enable device-wide output enable (DEV_OE) option in the Quartus II software. | Altera recommends you to tie the DEV_OE pin to VCCIO, GND, or leave the DEV_OE pin unconnected when you are not using this pin and when the pin is not used as an I/O pin. By default the DEV_OE pin is tri-stated. |

| MAX 10 Pin Name | Pin Type (1st and 2nd Function) | Pin Description | Connection Guidelines |
|-----------------|---------------------------------|--|--|
| JTAGEN | I/O | This is a dual-purpose pin. This pin functions according to the setting of the JTAG pin sharing option bit. If the JTAG pin sharing is not enabled, the JTAGEN pin is a regular I/O pin and JTAG pins function as JTAG dedicated pins. If the JTAG pin sharing is enabled and the JTAGEN pin is pulled low, JTAG pins function as dual-purpose pins. If the JTAG pin sharing is enabled and the JTAGEN pin is pulled high, JTAG pins function as JTAG dedicated pins. | In user mode, to use JTAG pins as regular I/O pins, tie the JTAGEN pin to a weak 1-k Ω pull-down. To use JTAG pins as dedicated pins, tie the JTAGEN pin to a weak 10-k Ω pull-up. |
| nCONFIG | Input, I/O | This is a dual-purpose pin, as an nCONFIG pin or a single-ended input pin in user mode. Before user mode, these pins function as configuration pins. During configuration mode, the pin name is nCONFIG. During user mode, the pin name is Input_only. If you pull this pin low during user mode the device will lose its configuration data, enter a reset state, and tri-state all I/O pins. Pulling this pin to a logic-high level initiates reconfiguration. | Upon power up, the nCONFIG pin must be pulled high. Connect this pin directly or through a 10-k Ω resistor to VCCIO. |

| MAX 10 Pin Name | Pin Type (1st and 2nd Function) | Pin Description | Connection Guidelines |
|-----------------|------------------------------------|--|---|
| nSTATUS | Bidirectional (open-drain), I/O | This is a dual-purpose pin, as an nSTATUS pin or a regular user I/O pin in user mode. By default, the nSTATUS pin is a dedicated configuration pin in user mode. The device drives the nSTATUS pin low immediately after power up and releases the pin after power-on reset (POR) time. As a status output, the nSTATUS pin is pulled low if an error occurs during configuration. As a status input, the device enters an error state when the nSTATUS pin is driven low by an external source during configuration or initialization. | Pull the nSTATUS pin high using an external $10\text{-k}\Omega$ pull-up resistor. Hot socketing is disabled for the nSTATUS pin. Due to this, a glitch maybe observed at the nSTATUS pin. To monitor the status of the pin, Altera recommends to implement input buffer with hysteresis and digital filtering with the sampling duration larger than 5.5 ms in the external device to avoid false trip. |
| TCK | Input, I/O | JTAG test clock input pin. This is a dual-purpose pin. | This TCK pin does not support internal weak pull-down. Connect this pin to an external $1-K\Omega-10-K\Omega$ pull-down resistor. By default this pin is tri-stated. |
| TDO | Output, I/O | This is a dual-purpose pin, as a JTAG TDO pin or a regular user I/O pin in user mode. | Altera recommends you to leave this pin unconnected if not used. By default this pin is tri-stated. |

| MAX 10 Pin Name | Pin Type (1st and 2nd Function) | Pin Description | Connection Guidelines |
|--|--|---|---|
| TDI | Input, I/O | This is a dual-purpose pin, as a JTAG TDI pin or a regular user I/O pin in user mode. You can disable the JTAG circuitry by connecting the TDI pin to VCC. | This pin has a weak internal pull-up. For configuration voltage of 2.5 V, 3.0 V, or 3.3 V, connect this pin through a 10-k Ω resistor to VCCA supply. For configuration voltage of 1.5 V and 1.8 V, connect this pin through a 10-k Ω resistor to VCCIO supply. |
| TMS | Input, I/O | This is a dual-purpose pin, as a JTAG TMS pin or a regular user I/O pin in user mode. You can disable the JTAG circuitry by connecting the TMS pin to VCC. | This pin has a weak internal pull-up. For configuration voltage of 2.5 V, 3.0 V, or 3.3 V, connect this pin through a 10-k Ω resistor to VCCA supply. For configuration voltage of 1.5 V and 1.8 V, connect this pin through a 10-k Ω resistor to VCCIO supply. |
| Differential I/O Pins | 1 | | |
| DIFFIO_RX_L[#:#][n,p], DIFFOUT_L[#:#][n,p] | I/O, dedicated RX channel, emulated LVDS output channel | When used as differential inputs, these are true LVDS receiver channels on left I/O banks. Pins with a "p" suffix carry the positive signal for the differential channel. Pins with an "n" suffix carry the negative signal for the differential channel. If not used for differential signaling, these pins are available as user I/O pins. When used as differential outputs, these are emulated LVDS output channels on left I/O banks. External resistor network is needed for emulated LVDS output buffers. Pins with a "p" suffix carry the positive signal for the differential channel. Pins with an "n" suffix carry the negative signal for the differential channel. If not used for differential signaling, these pins are available as user I/O pins. | Connect unused pins as defined in the Quartus II software. For the number of LVDS pair count for each MAX 10 device, refer to the respective device pinout file. |

| MAX 10 Pin Name | Pin Type (1st and 2nd Function) | Pin Description | Connection Guidelines |
|--|--|---|---|
| DIFFIO_RX_R[#:#][n,p], DIFFOUT_R[#:#][n,p] | I/O, dedicated RX channel, emulated LVDS output channel | When used as differential inputs, these are true LVDS receiver channels on right I/O banks. Pins with a "p" suffix carry the positive signal for the differential channel. Pins with an "n" suffix carry the negative signal for the differential channel. If not used for differential signaling, these pins are available as user I/O pins. When used as differential outputs, these are emulated LVDS output channels on right I/O banks. External resistor network is needed for emulated LVDS output buffers. Pins with a "p" suffix carry the positive signal for the differential channel. Pins with an "n" suffix carry the negative signal for the differential channel. If not used for differential signaling, these pins are available as user I/O pins. | Connect unused pins as defined in the Quartus II software. For the number of LVDS pair count for each MAX 10 device, refer to the respective device pinout file. |

| MAX 10 Pin Name | Pin Type (1st and 2nd Function) | Pin Description | Connection Guidelines |
|--|--|---|---|
| DIFFIO_RX_T[#:#][n,p], DIFFOUT_T[#:#][n,p] | I/O, dedicated RX channel, emulated LVDS output channel | When used as differential inputs, these are true LVDS receiver channels on top I/O banks. Pins with a "p" suffix carry the positive signal for the differential channel. Pins with an "n" suffix carry the negative signal for the differential channel. If not used for differential signaling, these pins are available as user I/O pins. When used as differential outputs, these are emulated LVDS output channels on top I/O banks. External resistor network is needed for emulated LVDS output buffers. Pins with a "p" suffix carry the positive signal for the differential channel. Pins with an "n" suffix carry the negative signal for the differential channel. If not used for differential signaling, these pins are available as user I/O pins. | Connect unused pins as defined in the Quartus II software. For the number of LVDS pair count for each MAX 10 device, refer to the respective device pinout file. |

| MAX 10 Pin Name | Pin Type (1st and 2nd Function) | Pin Description | Connection Guidelines |
|--|--|---|---|
| DIFFIO_RX_B[#:#][n,p], DIFFOUT_B[#:#][n,p] | I/O, dedicated RX channel, emulated LVDS output channel | When used as differential inputs, these are true LVDS receiver channels on bottom I/O banks. Pins with a "p" suffix carry the positive signal for the differential channel. Pins with an "n" suffix carry the negative signal for the differential channel. If not used for differential signaling, these pins are available as user I/O pins. When used as differential outputs, these are emulated LVDS output channels on bottom I/O banks. External resistor network is needed for emulated LVDS output buffers. Pins with a "p" suffix carry the positive signal for the differential channel. Pins with an "n" suffix carry the negative signal for the differential channel. If not used for differential signaling, these pins are available as user I/O pins. | Connect unused pins as defined in the Quartus II software. For the number of LVDS pair count for each MAX 10 device, refer to the respective device pinout file. |
| DIFFIO_TX_RX_B[#:#][n,p] | I/O, dedicated TX/RX channel | These are true LVDS transmitter channels or true LVDS receiver channels on bottom I/O banks. Pins with a "p" suffix carry the positive signal for the differential channel. Pins with an "n" suffix carry the negative signal for the differential channel. If not used for differential signaling, these pins are available as user I/O pins. | Connect unused pins as defined in the Quartus II software. For the number of LVDS pair count for each MAX 10 device, refer to the respective device pinout file. |

| MAX 10 Pin Name | Pin Type (1st and 2nd Function) | Pin Description | Connection Guidelines |
|-----------------|---------------------------------|---|--|
| High_Speed | I/O | These are I/O pins. High_Speed I/O pins have higher performance compared to Low_Speed I/O pins. High_Speed I/O pins reside in Banks 2, 3, 4, 5, 6, and 7. | Connect unused pins as defined in the Quartus II software. |
| Low_Speed | I/O | These are I/O pins. Low_Speed I/O pins have lower performance compared to High_Speed I/O pins. Low_Speed I/O pins reside in Banks 1A, 1B, and 8. | Connect unused pins as defined in the Quartus II software. |
| RDN | I/O, Input | This pin is required for each OCT RS calibration block. OCT is only applicable for right I/O banks (banks 5 and 6) of 10M16, 10M25, and 10M50 devices. This pin is a dual-purpose pin, you can use the RDN pin as a regular I/O pin if the OCT calibration is not used. When you use OCT calibration, connect the RDN pin to GND through an external resistor. | When you use OCT, tie these pins to GND through either a 25-, 34-, 40-, 48-, or $50-\Omega$ resistor depending on the desired I/O standard. When the device does not use this dedicated input pin for the external precision resistor or as an I/O pin, Altera recommends you to connect the RDN pin to GND. |

| MAX 10 Pin Name | Pin Type (1st and 2nd Function) | Pin Description | Connection Guidelines |
|--------------------------------|---------------------------------|--|--|
| RUP | I/O, Input | This pin is required for each OCT RS calibration block. OCT is only applicable for right I/O banks (banks 5 and 6) of 10M16, 10M25, and 10M50 devices. This pin is a dual-purpose pin, you can use the RUP pin as a regular I/O pin if the OCT calibration is not used. When you use OCT calibration, connect the RUP pin to VCCN through an external resistor. | When you use OCT, tie these pins to the required VCCIO banks through either a 25-, 34-, 40-, 48-, or 50-Ω resistor depending on the desired I/O standard. When the device does not use this dedicated input pin for the external precision resistor or as an I/O pin, Altera recommends you to connect the RUP pin to VCCIO of the bank in which the RUP pin resides or GND. |
| VREFB<#>N0 | Power, I/O | These pins are dual-purpose pins. For Banks 1A and 1B, VREF pins are shared. Input reference voltage for each I/O bank. If a bank uses a voltage referenced I/O standard for input operation, then these pins are used as the voltage-reference pins for the bank. | If you are not using the VREF pins in banks or shared banks, connect unused pins as defined in Quartus II software. When VREF pins are used as I/O pins, they have higher capacitance than regular I/O pins which will slow the edge rates and affect I/O timing. |
| External Memory Interface Pins | T | <u></u> | <u></u> |
| DQ[#]R | I/O, DQ | Optional data signal for use in external memory interfacing. The order of the DQ bits within a designated DQ bus is not important. However, use with caution when making pin assignments if you plan on migrating to a different memory interface that has a different DQ bus width. | Connect unused pins as defined in Quartus II software. |

| MAX 10 Pin Name | Pin Type (1st and 2nd Function) | Pin Description | Connection Guidelines |
|-----------------|---------------------------------|--|---|
| DQS[#]R | I/O, DQS | Optional data strobe signal for use in external memory interfacing. | Connect unused pins as defined in Quartus II software. |
| DQSn[#]R | I/O, DQSn | Optional complementary data strobe signal for use in external memory interfacing. | Connect unused pins as defined in Quartus II software. |
| DM[#]R | I/O, DM | A low signal on the DM pin indicates that the write is valid. Driving the DM pin high results in the memory masking of the DQ signals. | Connect unused pins as defined in Quartus II software. |
| CK_[6] | I/O, Output | Input clock for external memory devices. | Connect unused pins as defined in the Quartus II software. |
| CK#_[6] | I/O, Output | Input clock for external memory devices, inverted CK. | Connect unused pins as defined in the Quartus II software. |
| Reference Pins | | | |
| GND | Ground | Device ground pins. | Altera recommends you to tie REFGND to the GND pin with an isolating ferrite bead for the best ADC performance. Connect all GND pins to the board GND plane. |
| NC | No Connect | Do not drive signals into these pins. | When designing for device migration you may connect these pins to power, ground, or a signal trace depending on the pin assignment of the devices selected for migration. However, if device migration is not a concern, leave these pins floating. |

| MAX 10 Pin Name | Pin Type (1st and 2nd Function) | Pin Description | Connection Guidelines | |
|---------------------|---------------------------------|---|--|--|
| Voltage Sensor Pins | | | | |
| ADC[12]IN[116] | I/O, Input | These multi-purpose pins support single-ended analog input and can be used as regular digital I/O pins. When not used as analog input pins, these pins can be used as any other digital I/O pins. ADCIN[8] and ADCIN[16] pins support the prescalar feature in the dual power supply devices which allows analog input greater than its reference voltage. The allowable input range is 0V – 3.3V, and the conversion result is divided by half. For 10M08 and 10M16 devices, ADC1IN[18] pins are available for the single power supply devices and ADC1IN[116] pins are available for the dual power supply devices. For 10M25 and 10M50 devices, ADC1IN[18] and ADC2IN[18] pins are available for both single and dual power supply devices. | All digital I/O pins will be tri-stated if any of these pins is configured as an analog input pin. For unused ADCIN pins, Altera recommends you to connect them to GND. No parallel routing between analog input signals and I/O traces. Crosstalk requirement is from -100 dB to 2 GHz. Route the analog input signal adjacent to the REFGND. Total RC value including package, trace, and driver parasitic values should be lesser than 42.4 ns. This is to ensure the input signal is fully settled during the sampling phase. Connect the 10-Ω resistor in series, followed by a 1 pF capacitor to ground. Place the capacitor closer to the pin. The RC filter ground reference is REFGND. For details about the board design guidelines, refer to the MAX 10 ADC User Guide. | |

| MAX 10 Pin Name | Pin Type (1st and 2nd Function) | Pin Description | Connection Guidelines |
|-----------------|---------------------------------|--|---|
| ADC_VREF | Input | Analog-to-digital converter (ADC) voltage reference input. | Tie the ADC_VREF pin to an external accurate voltage reference source. If you are not using the external reference, this pin is a no connect (NC). No parallel routing between analog input signals and I/O traces. Crosstalk requirement is from -100 dB to 2 GHz. Low pass filter is required at each analog input pin used to filter out unwanted noise. Place the filter closer to the input pin. Connect the 1- Ω resistor in series, followed by a 10 uF resistor to ground. Place the decoupling of 1 uF cap closer to the pin. The RC filter ground reference is REFGND. |

| MAX 10 Pin Name | Pin Type (1st and 2nd Function) | Pin Description | Connection Guidelines |
|-----------------|---------------------------------|---|---|
| ANAIN[1] | Input | This is a dedicated single-ended analog input pin for ADC1. | If this pin is not used, Altera recommends you to connect them to GND. No parallel routing between analog input signals and I/O traces. Crosstalk requirement is from -100 dB to 2 GHz. Route the analog input signal adjacent to the REFGND. Total RC value including package, trace, and driver parasitic values should be lesser than 42.4 ns. This is to ensure the input signal is fully settled during the sampling phase. Connect the 10-Ω resistor in series, followed by a 1 pF capacitor to ground. Place the capacitor closer to the pin. The RC filter ground reference is REFGND. For details about the board design guidelines, refer to the MAX 10 ADC User Guide. |

| MAX 10 Pin Name | Pin Type (1st and 2nd Function) | Pin Description | Connection Guidelines |
|-----------------|---------------------------------|---|--|
| ANAIN[2] | Input | This is a dedicated single-ended analog input pin for ADC2. This pin is not available in each device density and package combination. For details, refer to the specific device pinout file. | If this pin is not used, Altera recommends you to connect them to GND. No parallel routing between analog input signals and I/O traces. Crosstalk requirement is from -100 dB to 2 GHz. The RC filter ground reference is REFGND. Total RC value including package, trace, and driver parasitic values should be lesser than 42.4 ns. This is to ensure the input signal is fully settled during the sampling phase. The RC filter ground reference is AVSSREF. Connect the 10-Ω resistor in series, followed by a 1 pF capacitor to ground. Place the capacitor closer to the pin. For details about the board design guidelines, refer to the MAX 10 ADC User Guide. |
| REFGND | Input | This pin is the ADC ground reference pin for ANAIN pins. | Altera recommends you to tie REFGND to the GND pin with an isolating ferrite bead for the best ADC performance. If you are not using ADC, tie this pin directly to GND. |

| MAX 10 Pin Name | Pin Type (1st and 2nd Function) | Pin Description | Connection Guidelines |
|------------------------------|---------------------------------|---|---|
| MAX 10S (Single Supply) FPGA | , | | |
| VCC_ONE | Power | Power supply pin for core and periphery through an on-die regulator. The voltage is internally regulated to | The VCC_ONE power supply pin supports E144, M153, and U169 package-types only. Connect all VCC_ONE pins to either 3.0- or 3.3-V power supply. Tie VCC_ONE and VCCA |
| | | 1.2V to supply power to the core and periphery. | with filter using the same power supply on board level. |
| | | | Connect these pins to 1.2-, 1.35-, 1.5-, 1.8-, 2.5-, 3.0-, or 3.3-V power supplies, depending on the I/O standard assigned to each I/O bank. |
| | | | If you are migrating from other MAX 10 devices to the 10M02 device, the VCCIO1A and VCCIO1B pins are shorted to the VCCIO1 pin of the 10M02 device. |
| VCCIO[#] | Power | I/O supply voltage pins for banks 1 through 8. Each bank supports different voltage level. The VCCIO pin supplies power to the input and output buffers for all I/O standards. | If you enable ADC, connect VCCIO1A and VCCIO1B pins to the same voltage level, either 3.0- or 3.3-V depending on the VCCA_ADC pins used. The power supply sharing between VCCIO1A and VCCIO1B pins requires filtering to isolate the noise. The filter should be located near to VCCIO1A pins. Only 10M02 devices do not require filtering if VCCIO1A and VCCIO1B |
| | | The VCCIO pin powers up the JTAG and configuration pins. | share the same power supply. If you are migrating from the 10M08 or 10M16 device to the 10M02 device with ADC enabled, replace the filter with 0- Ω resistor in the 10M02 device. |
| | | | For details about the available VCCIO pins for each MAX 10 device, refer to the respective device pinout file. See Note 4. |
| | | | Decoupling of these pins depends on the design decoupling requirements of the specific board. |

| MAX 10 Pin Name | Pin Type (1st and 2nd Function) | Pin Description | Connection Guidelines |
|----------------------------|---------------------------------|--|---|
| VCCA[16] | Power | Power supply pins for PLL and ADC block. | Connect these pins to a 3.0- or 3.3-V power supplies even if the PLL and ADC are not used. These pins must be powered up and powered down at the same time. Connect all VCCA pins together. VCCA power supply to the FPGA should be isolated for better jitter performance. See Notes 5 and 6. VCCA[14] is available for M153 and U169 packages while VCCA[16] is available for the E144 package. |
| MAX 10D (Dual Supply) FPGA | | | |
| VCC | Power | Power supply pin for core and periphery. | Connect all VCC pins to 1.2-V power supply. Decoupling of these pins depends on the design decoupling requirements of the specific board. See Note 4. |

| MAX 10 Pin Name | Pin Type (1st and 2nd Function) | Pin Description | Connection Guidelines |
|-----------------|---------------------------------|---|--|
| VCCIO[#] | Power | I/O supply voltage pins for banks 1 through 8. Each bank supports different voltage level. The VCCIO pin supplies power to the input and output buffers for all I/O standards. The VCCIO pin powers up the JTAG and configuration pins. | Connect these pins to 1.2-, 1.35-, 1.5-, 1.8-, 2.5-, 3.0-, or 3.3-V power supplies, depending on the I/O standard assigned to each I/O bank. If you are migrating from other MAX 10 devices to the 10M02 device, the VCCIO1A and VCCIO1B pins are shorted to the VCCIO1 pin of the 10M02 device. If you enable ADC, connect VCCIO1A and VCCIO1B pins to the same voltage level, 2.5-V. The power supply sharing between VCCIO1A and VCCIO1B pins requires filtering to isolate the noise. The filter should be located near to VCCIO1A pins. Only 10M02 devices do not require filtering if VCCIO1A and VCCIO1B share the same power supply. If you are migrating from the 10M08 or 10M16 device to the 10M02 device with ADC enabled, replace the filter with 0- Ω resistor in the 10M02 device. For details about the available VCCIO pins for each MAX 10 device, refer to the respective device pinout file. Decoupling of these pins depends on the design decoupling requirements of the specific board. See Note 4. |

| MAX 10 Pin Name | Pin Type (1st and 2nd Function) | Pin Description | Connection Guidelines |
|-----------------|---------------------------------|--|--|
| VCCA[14] | Power | Power supply pins for PLL analog block. | Connect these pins to a 2.5-V power supply even if the PLL is not used. These pins must be powered up and powered down at the same time. Connect all VCCA pins together. VCCA power supply to the FPGA should be isolated for better jitter performance. See Notes 5 and 6. |
| VCCD_PLL[14] | Power | Power supply pins for PLL digital block. | Connect VCCD_PLL[14] pins to 1.2-V power supply even if the PLL is not used. Connect all VCCD_PLL[14] pins together. Altera recommends you to keep these pins isolated from other VCC pins for better jitter performance. See Notes 5 and 7. |
| VCCA_ADC | Power | Power supply pin for ADC analog block. | Connect the VCCA_ADC pin to the recommended power supply specification for the best ADC performance. Tie the VCCA_ADC pin to any 2.5V power domain if you are not using ADC, and do not tie the VCCA_ADC pin to GND. Decoupling of these pins depends on the design decoupling requirements of the specific board. See Note 4. |

| MAX 10 Pin Name | Pin Type (1st and 2nd Function) | Pin Description | Connection Guidelines |
|-----------------|---------------------------------|---|--|
| VCCINT | Power | Power supply pin for ADC digital block. | Connect the VCCINT pin to the recommended power supply specification for the best ADC performance. Tie the VCCINT pin to any 1.2V power domain if you are not using ADC. Decoupling of these pins depends on the design decoupling requirements of the specific board. See Note 4. |

Altera recommends that you create a Quartus II design, enter your device I/O assignments, and compile the design. The Quartus II software will check your pin connections according to I/O assignment and placement rules. The rules differ from one device to another based on device density, package, I/O assignments, voltage assignments, and other factors that are not fully described in this document or the device handbook.

Notes to Pin Connection Guidelines

Altera provides these guidelines only as recommendations. It is the responsibility of the designer to apply simulation results to the design to verify proper device functionality.

- 1. These pin connection guidelines are created based on the MAX 10 FPGA device family.
- 2. The number of dedicated global clocks for each device density is different.
- 3. The unused pins must be connected as specified in the Quartus II software settings. The default Quartus II setting for unused pins is 'As inputs tri-stated with weak pull-up resistors', unless for specific pins that Quartus II software connects them to GND automatically.
- 4. Capacitance values for the power supply decoupling capacitors should be selected after consideration of the amount of power needed to supply over the frequency of operation of the particular circuit being decoupled. A target impedance for the power plane should be calculated based on current draw and voltage drop requirements of the device/supply. The power plane should then be decoupled using the appropriate number of capacitors. On-board capacitors do not decouple higher than 100 MHz due to "Equivalent Series Inductance" of the mounting of the packages. Proper board design techniques such as interplane capacitance with low inductance should be considered for higher frequency decoupling. To assist in decoupling analysis, Altera's "Power Distribution Network (PDN) Design Tool" serves as an excellent decoupling analysis tool. The PDN design tool can be obtained at Power Distribution Network Design Tool.

To calculate the target impedance of each MAX 10 device supply, you should use the following transient current and voltage ripple percentages:

| MAX 10 Supply Rail | Transient Current (%) | Voltage Ripple (%) |
|--------------------|-----------------------|--------------------|
| VCC | 50 | 5 |
| VCCIO | 100 | 5 |
| VCCA | 10 | 5 |
| VCCD_PLL | 10 | 3 |
| VCCA_ADC | 50 | 2 |
| VCCINT | 50 | 3 |

Setting Ftarget to 70 MHz or higher should result in a robust PDN.

- 5. Use separate power islands for VCCA and VCCD_PLL. PLL power supply may originate from another plane on the board but must be isolated using a ferrite bead or other equivalent methods. If using a ferrite bead, choose an 0402 package with low DC resistance, higher current rating than the maximum steady state current for the supply it is connected to(VCCA or VCCD_PLL) and high impedance at 100 MHz.
- 6. The VCCA power island can be decoupled with a combination of decoupling capacitors. Please refer to the Power Distribution Network Design Tool to determine the decoupling capacitors value. Use 0402 package for 0.1 uF and smaller capacitors for lower mounting inductance. Place 0.1 uF and smaller capacitors as close to the device as possible. On-board capacitors do not decouple higher than 100 MHz due to "Equivalent Series Inductance" of the mounting of the packages. Proper board design techniques such as interplane capacitance with low inductance should be considered for higher frequency decoupling. To minimize impact on jitter, a 20 mV ripple voltage was used in the analysis for VCCA decoupling.
- 7. The VCCD_PLL power island can be decoupled with a combination of decoupling capacitors. Please refer to the "Power Distribution Network Design Tool" at Power Distribution Network Design Tool" at Power Distribution Network Design Tool to determine the decoupling capacitors value. Place 0.1 uF and smaller capacitors as close to the device as possible. On-board capacitors do not decouple higher than 100 MHz due to "Equivalent Series Inductance" of the mounting of the packages. Proper board design techniques such as interplane capacitance with low inductance should be considered for higher frequency decoupling. To minimize impact on jitter, a 20 mV ripple voltage was used in the analysis for VCCD_PLL decoupling.
- 8. All configuration pins used in user mode are low-speed I/Os.
- 9. Low Noise Switching Regulator defined as a switching regulator circuit encapsulated in a thin surface mount package containing the switch controller, power FETs, inductor, and other support components. The switching frequency is usually between 800kHz and 1MHz and has fast transient response. The switching frequency range is not an Altera requirement. However, Altera does require the Line Regulation and Load Regulation meet the following specifications:
 - Line Regulation < 0.4%
 - Load Regulation < 1.2%
- 10. If you disable the "Auto-reconfigure from secondary image when initial image fails" option in the Quartus II software when generating the POF file, the FPGA will always load the configuration image 0 without sampling the physical CONFIG_SEL pin during power up.

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MAX 10 FPGA

Example 1. Power Supply Sharing Guidelines for MAX 10D (Dual Supply) FPGA

Example Requiring 3 Power Regulators

| Power Pin Name | Regulator Count | Voltage Level (V) | Supply Tolerance | Power Source | Regulator Sharing | Notes |
|----------------|-----------------|----------------------|---------------------|-----------------|-------------------|--|
| VCC | | | | | Share | |
| VCCINT | 1 | 1.2 | ± 50mV | Switcher (*) | Isolate | May be able to share VCCINT and VCCD_PLL with VCC with proper isolation filters. |
| VCCD_PLL | | | | | | |
| VCCA | 2 | 2.5 | ± 5% | Switcher (*) | Share | May be able to share VCCA_ADC with VCCA with proper isolation filters. |
| VCCA_ADC | 2 | 2.5 | ± 3% | Switcher () | Isolate | iviay be able to share voor_rbc with voor with proper isolation litters. |
| VCCIO | 3 | Varies | ± 5% | Switcher (*) | Share | Individual power rail. |

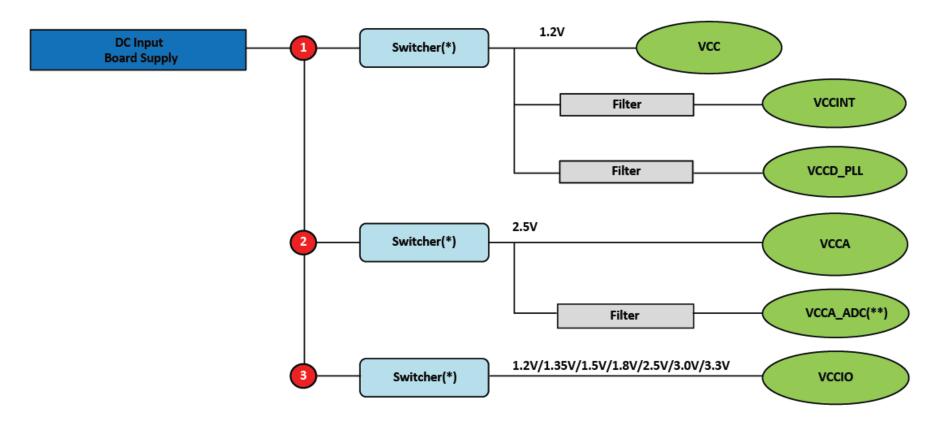
(*)When using a switcher to supply these voltages, the switcher must be a low noise switcher as defined in note 9 of the Notes to Pin Connection Guidelines.

Notes:

- (1) Use the EPE (Early Power Estimation) tool to assist in determining the power required for your specific design.
- (2) Each board design requires its own power analysis to determine the required power regulators needed to satisfy the specific board design requirements. An example block diagram using the MAX 10 FPGA device is provided in Figure 1.
- (3) The voltage level for each power rail is preliminary.
- (4) The MAX 10 performance is guaranteed with the recommended Enpirion power solutions. For a list of recommended Enpirion solutions for MAX 10 devices, refer to the <u>PowerPlay Early Power Estimators (EPE) and Power Analyzer</u> page. The recommended Enpirion solutions are included in the summary report. For more details about the Enpirion power solutions, refer to the <u>Enpirion Power page</u>.
- (5) For LPDDR2 interface targeting 200MHz, you need to constraint the memory device I/O and core power supply to ± 3% variation.

Altera recommends that you create a Quartus[®] II design, enter your device I/O assignments, and compile the design. The Quartus II software will check your pin connections according to I/O assignment and placement rules. The rules differ from one device to another based on device density, package, I/O assignments, voltage assignments, and other factors that are not fully described in this document or the device handbook.

Figure 1. Example Power Supply Sharing Guidelines for MAX 10D (Dual Supply) FPGA



The ADC power supply requires 0.1uF decoupling cap near the package and ferrite bead filter at power supply.

(*)When using a switcher to supply these voltages, the switcher must be a low noise switcher as defined in note 9 of the Notes to Pin Connection Guidelines.

^(**) Ferrite beads should be connected in series followed by a 10uF capacitor to ground. Place the decoupling of 0.1uF cap closer to the pin.

Altera recommends that you create a Quartus[®] II design, enter your device I/O assignments, and compile the design. The Quartus II software will check your pin connections according to I/O assignment and placement rules. The rules differ from one device to another based on device density, package, I/O assignments, voltage assignments, and other factors that are not fully described in this document or the device handbook.

MAX 10 FPGA

Example 2. Power Supply Sharing Guidelines for MAX 10S (Single Supply) FPGA – E144, M153, and U169 Packages Example Requiring 2 Power Regulator

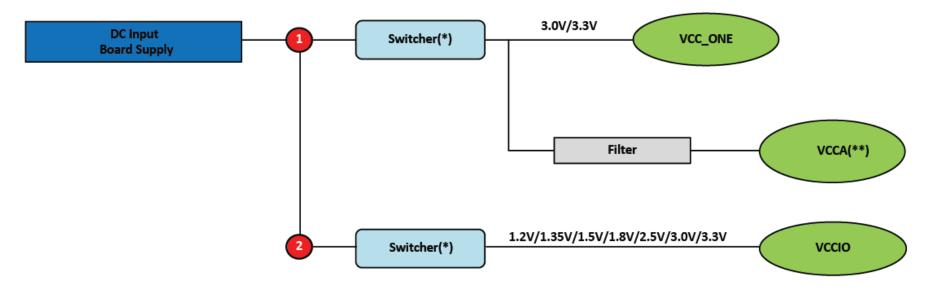
| Power Pin Name | Regulator Count | Voltage Level (V) | Supply Tolerance | Power Source | Regulator Sharing | Notes |
|----------------|-----------------|----------------------|---------------------|-----------------|-------------------|---|
| VCC_ONE | 1 | 3.0/3.3 | ± 5% | Switcher (*) | Share | Both VCCA and VCC_ONE must share a single power source with proper isolation filters. |
| VCCA | ı | 3.0/3.3 | | | Isolate | |
| VCCIO | 2 | Varies | ± 5% | Switcher (*) | Share | Individual power rail. |

(*)When using a switcher to supply these voltages, the switcher must be a low noise switcher as defined in note 9 of the Notes to Pin Connection Guidelines.

Notes:

- (1) Use the EPE (Early Power Estimation) tool to assist in determining the power required for your specific design.
- (2) Each board design requires its own power analysis to determine the required power regulators needed to satisfy the specific board design requirements. An example block diagram using the MAX 10 FPGA device is provided in Figure 2.
- (3) The voltage level for each power rail is preliminary.
- (4) The MAX 10 performance is guaranteed with the recommended Enpirion power solutions. For a list of recommended Enpirion solutions for MAX 10 devices, refer to the <u>PowerPlay Early Power Estimators (EPE) and Power Analyzer</u> page. The recommended Enpirion solutions are included in the summary report. For more details about the Enpirion power solutions, refer to the <u>Enpirion Power</u> page.

Figure 2. Example Power Supply Sharing Guidelines for MAX 10S (Single Supply) FPGA - E144, M153, and U169 Packages



^(*) When using a switcher to supply these voltages, the switcher must be a low noise switcher as defined in note 9 of the Notes to Pin Connection Guidelines.

^(**) The VCCA power supply requires ferrite bead filter for noise isolation.

Altera recommends that you create a Quartus[®] II design, enter your device I/O assignments, and compile the design. The Quartus II software will check your pin connections according to I/O assignment and placement rules. The rules differ from one device to another based on device density, package, I/O assignments, voltage assignments, and other factors that are not fully described in this document or the device handbook.

Revision History

| Revision | Description of Changes | Date |
|----------|---|------------|
| 1.0 | Initial release. | 9/22/2014 |
| 1.1 | Added note 10 in the Notes to Pin Connection Guidelines. Added note (**) to Figure 2. Updated the pin name from BOOT_SEL to CONFIG_SEL. Updated the pin description of the CONFIG_SEL pin. Updated the connection guidelines of the VCC_ONE pin. Updated the connection guidelines of the nSTATUs pin. Updated the connection guidelines of the CONF_DONE pin. Updated note 4 in the Notes to Pin Connection Guidelines. | 12/15/2014 |
| 1.2 | Updated the connection guidelines of the DPCLK[03] pins. Updated the connection guidelines of the PLL_[L,R,B,T]_CLKOUTp and PLL_[L,R,B,T]_CLKOUTn pins. Updated the connection guidelines of the VREFB<#>N0 pins. Updated the pin description of the ADC[12]IN[116] pins. | 1/29/2015 |